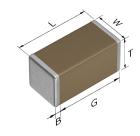
## 积层贴片陶瓷片式电容器

## C3216X6S1V335K160AB

RoHS Reach Halogen Free Pb Free

交货型号	C3216X6S1V335KT****
用途	一般等级
特点	General 一般(~75V)
系列	C3216 [EIA 1206]
状态	▲ 量产体制(新设计非推荐)



	₹५
长度(L)	3. 20mm $\pm 0.20$ mm
宽度(W)	1.60mm ±0.20mm
厚度(T)	1.60mm $\pm 0.20$ mm
端子宽度(B)	0.20mm Min.
端子间隔(G)	1.00mm Min.
推荐焊盘布局(PA)	2.10mm to 2.50mm(Flow Soldering)
1世代/年益/41/10 (1 亿/	2.00mm to 2.40mm(Reflow Soldering)
推荐焊盘布局(PB)	1.10mm to 1.30mm(Flow Soldering)
J世行·阡益·阳/四(t D)	1.00mm to 1.20mm(Reflow Soldering)
推荐焊盘布局(PC)	1.00mm to 1.30mm(Flow Soldering)
1世分が加工中/円(はて)	1.10mm to 1.60mm(Reflow Soldering)

电气特性		
电容	$3.3\mu\text{F}~\pm10\%$	
额定电压	35VDC	
温度特性	X6S (±22%)	
耗散因数(Max.)	5%	
绝缘电阻 (Min.)	151ΜΩ	

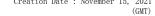
	其他	
MT +0×.→->+	流体	
焊接方法	回流	
AEC-Q200	NO	
包装形式	塑封编带(180mm卷筒)	
包装个数	2000pcs	

<sup>!</sup> Images are for reference only and show exemplary products.

<sup>!</sup> This PDF document was created based on the data listed on the TDK Corporation website.

<sup>!</sup> All specifications are subject to change without notice.

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特性图表(这是参考数据,并不保证产品的特性。)

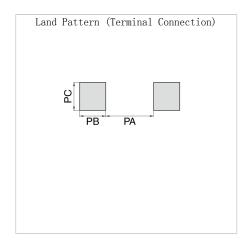
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## Associated Images



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